NOTES:
1. PIN ASSIGNMENT SEE TO WIRE LIST.
2. WITH COPPER SHIELD AFTER INNER MOLDING.
3. ELECTRICAL TEST CONDITION:
   (a). 100% OPEN, SHORT & MISWIRE TEST,
   (b). INSULATOR RESISTANCE: 10 Mohm MIN.
   DC 300V 0.01sec.
   (c). CONTACT RESISTANCE: 3 ohm MAX.

PIN ASSIGNMENT

P1
1--------------------------------------------1
2--------------------------------------------2
3--------------------------------------------3
4--------------------------------------------4
S--------------------------------------------S

P2

1. PIN ASSIGNMENT SEE TO WIRE LIST.
2. WITH COPPER SHIELD AFTER INNER MOLDING.
3. ELECTRICAL TEST CONDITION:
   (a). 100% OPEN, SHORT & MISWIRE TEST,
   (b). INSULATOR RESISTANCE: 10 Mohm MIN.
   DC 300V 0.01sec.
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